Regularities and mechanisms of copper surface relief formation under pulsed laser action

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An experimental study and molecular dynamic (MD) modeling of the formation of surface relief (known as the optoplastic effect) and the microstructure of thin near-surface layers of copper after exposure to laser pulses of nanosecond duration with parameters corresponding to the absence of ablation have been carried out. The determining role of thermoplasticity, realized by the formation of deformation twins in the form of nanoscale plates, as well as dislocation walls of slip systems $\{111\}\langle110\rangle$ and $\{111\}\langle110\rangle$ common for the FCC lattice of copper, is established. The results of MD modeling are confirmed by experimental data, which allows validating the model for the processes in materials under laser exposure under the specified conditions.

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^[1] Malinsky T V, Rogalin V E and Yamshchikov V A 2022 *Physics of Metals and Metallography* **123** 192–199 [in Russian]

^[2] Zhakhovsky V, Kolobov Y, Ashitkov S, Inogamov N, Nelasov I, Manokhin S, Khokhlov V, Ilnitsky D, Petrov Y, Ovchinnikov A, Chefonov O and Sitnikov D 2023 Physics of Fluids 35 096104